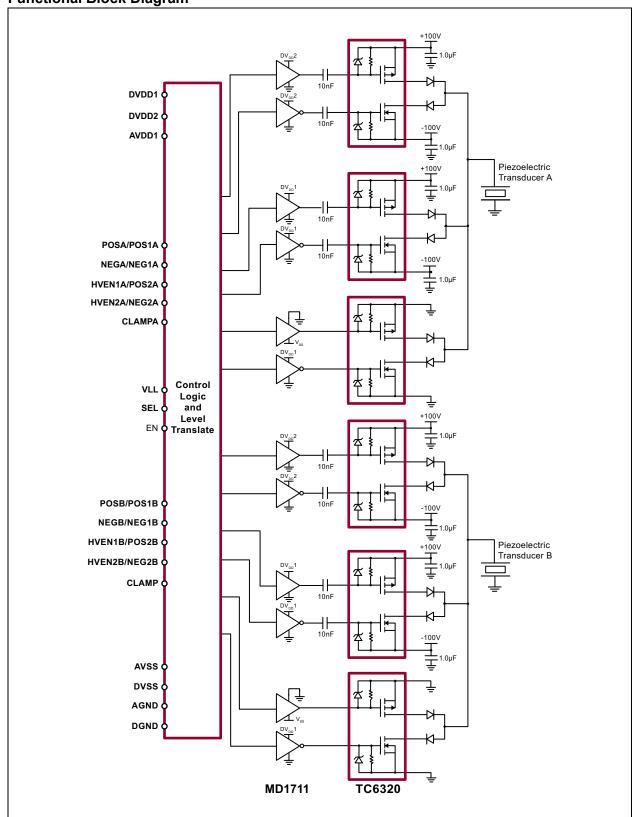
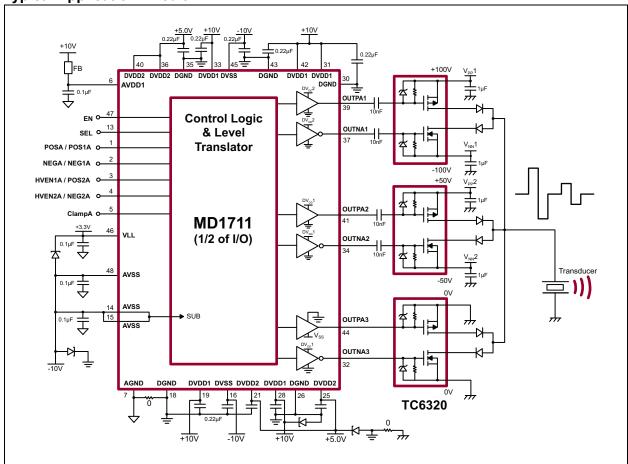
Functional Block Diagram



Typical Application Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Logic Supply Voltage, V _{I I}	
Positive Gate Drive Supply, AV _{DD1} , DV _{DD2} , DV _{DD2}	–0.5V to +15V
Negative Gate Drive Supply, AV _{SS} , DV _{SS}	–15V to +0.5V
Operating Junction Temperature, T _J	
Storage Temperature, T _S	
Power Dissipation (48-lead LQFP)	
Power Dissipation (48-lead QFN)	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

OPERATING SUPPLY VOLTAGES AND CURRENTS

Electrical Specifications: Over operating conditions unless otherwise specified, $AV_{DD}1 = DV_{DD}1 = DV_{DD}2 = 10V$, $AV_{SS} = DV_{SS} = -10V$, $V_{LL} = 3.3V$, $T_A = 25$ °C.

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
Logic Supply	V_{LL}	1.8	3.3	5	V	
Positive Drive Bias Supply	AV _{DD1}	8	10	12.6	V	
Positive Gate Drive Supply	DV _{DD1}	4.75	_	12.6	V	
Positive Gate Drive Supply	DV _{DD2}	4.75	_	12.6	V	
Negative Gate Drive and Bias Supply	AV _{SS} , DV _{SS}	-12	-10	-8	V	
Logic Supply Current	I _{VLL}	_	2	_	mA	
Positive Bias Current	I _{AVDD1}	_	5	_	mA	All channels on at 5 MHz
Negative Drive and Bias Supply Currents	I _{AVSS} , I _{DVSS}		20	_	mA	All channels on at 5 MHz, no load
Positive Drive Current 1	I _{DVDD1}	_	55	_	mA	
Positive Drive Current 2	I _{DVDD2}	_	13	_	mA	All channels on at 5 MHz, DV _{DD} 2 = 5V, no load
V _{AVDD1} Quiescent Current	I _{AVDD1Q}	_	2	_	mA	
V _{AVSS} Quiescent Current	I _{AVSSQ}	_	0.75	_	mA	ENI La Allia de la Cara
V _{DVDD1} Quiescent Current	I _{DVDD1Q}	_	_	10	μΑ	EN = low, all inputs low or high
V _{DVDD2} Quiescent Current	I _{DVDD2Q}	_	_	10	μΑ	1"9"
Logic Supply Current	I _{VLLQ}	_	1	_	mA	

DC ELECTRICAL CHARACTERISTICS

Electrical Specifications: Over operating conditions unless otherwise specified, $AV_{DD}1 = DV_{DD}1 = DV_{DD}2 = 10V$, $AV_{SS} = DV_{SS} = -10V$, $V_{LL} = 3.3V$, $V_{AL} = 0$ °C to 70°C.

Parameter		Sym.	Min.	Тур.	Max.	Unit	Conditions				
P-CHANNEL AND N-CHANNE	L GATE DRIV	/ER OUTP	JTS								
Output Sink Booistones	P-Channel	В	_		6	Ω	I _{SINK} = 100 mA				
Output Sink Resistance	N-Channel	R _{SINK}	_		10	Ω	I _{SINK} = 100 mA				
Output Source resistance	P-Channel	D	_	I	6	Ω	I _{SOURCE} = 100 mA				
Output Source resistance	N-Channel	R _{SOURCE}	_		10	Ω	I _{SOURCE} = 100 mA				
Peak Output Sink Current	P-Channel	1.	_	2		Α					
Feak Output Sink Current	N-Channel	I _{SINK}	_	1.5	_	Α					
Peak Output Source Current	P-Channel	1	_	2	_	Α					
Feak Output Source Current	N-Channel	ISOURCE	_	1.5	_	Α					
LOGIC INPUTS											
Input Logic High Voltage		V _{IH}	0.8 V _{LL}	_	V_{LL}	V					
Input Logic Low Voltage		V _{IL}	0		0.2 V _{LL}	V					
Input Logic High Current	I _{IH}	_		1	μΑ						
Input Logic Low Current		I _{IL}	-1	_		μΑ					

AC ELECTRICAL CHARACTERISTICS

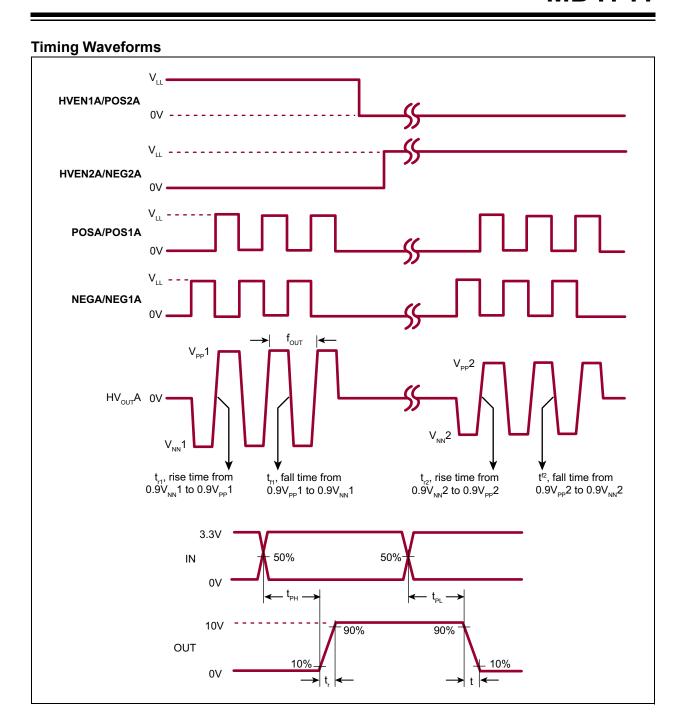
Electrical Specifications: Over operating conditions unless otherwise specified, $AV_{DD}1 = DV_{DD}1 = DV_{DD}2 = 10V$, $AV_{SS} = DV_{SS} = -10V$, $V_{LL} = 3.3V$, $V_{LL} = 0^{\circ}C$ to $V_{LL} = 0^{\circ}C$

AVSS - DVSS10V, VLL - 3.5V, 1A - 0 0 0	070 0.							
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions		
Output Frequency Range	f _{OUT}	_	_	20	MHz			
Propagation Delay when Output is from Low to High	t _{PH}		19	l	ns	No load (See Timing Waveforms .)		
Propagation Delay when Output is from High to Low	t _{PL}		19		ns	No load (See Timing Waveforms .)		
Output Rise Time	t _r		8	l	ns	1000 pF load (See Timing Waveforms .)		
Output Fall Time	t _f	_	8	_	ns	1000 pF load (See Timing Waveforms .)		
Delay Time Matching	Δt _{DM}		_	±3	ns	No load, from device to device		
Output Jitter	Δt _{DLAY}	_	30	_	ps	Standard deviation of t _D samples (1 kHz)		
Output Slew Rate	SR	_	12		V/ns	Measured at TC6320 out-		
Second Harmonic Distortion	HD2	_	-40		dB	put with 100Ω load		

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TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions						
TEMPERATURE RANGE												
Operating Junction Temperature	TJ	0	_	+125	°C							
Storage Temperature	T _S	-65	_	+150	°C							
PACKAGE THERMAL RESISTANCE												
48-lead LQFP	θ_{JA}	_	52	_	°C/W							
48-lead QFN	θ_{JA}	_	18	_	°C/W							



2.0 PIN DESCRIPTION

Functional descriptions for the pins are listed in Table 2-1. See **Package Types** for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	POSA/POS1A	Logic input control for Channel A. When SEL = L, the pin is POSA. When SEL = H, the pin is POS1A.
2	NEGA/NEG1A	Logic input control for Channel A. When SEL = L, the pin is NEGA. When SEL = H, the pin is NEG1A.
3	HVEN1A/POS2A	Logic input control for Channel A. When SEL = L, the pin is HVEN1A. When SEL = H, the pin is POS2A.
4	HVEN2A/NEG2A	Logic input control for Channel A. When SEL = L, the pin is HVEN2A. When SEL = H, the pin is NEG2A.
5	CLAMPA	Used with SEL = H. Logic input control for OUT–PA3 and OUT–NA3. Connect to ground when SEL = L.
6	AVDD1	Supplies analog circuitry portion of the gate driver. Should be at the same potential as DVDD1.
7	AGND	Analog Ground
8	CLAMPB	Used with SEL = H. Logic input control for OUT–PB3 and OUT–NB3. Connect to ground when SEL = L.
9	HVEN2B/NEG2B	Logic input control for Channel B. When SEL = L, the pin is HVEN2B. When SEL = H, the pin is NEG2B.
10	HVEN1B/POS2B	Logic input control for Channel B. When SEL = L, the pin is HVEN1B. When SEL = H, the pin is POS2B.
11	NEGB/NEG1B	Logic input control for Channel B. When SEL = L, the pin is NEGB. When SEL = H, the pin is NEG1B.
12	POSB/POS1B	Logic input control for Channel B. When SEL = L, the pin is POSB. When SEL = H, the pin is POS1B.
13	SEL	Logic input select. See Table 3-2 for SEL = L and Table 3-3 for SEL = H.
14 15	AVSS	Negative driver supply for OUT–PA3, OUT–PB3 and bias circuits. It is also connected to the IC substrate. It should be connected to the most negative potential.
16	DVSS	Gate drive supply voltage for OUT–PA3 and OUT–PB3. Supplies digital circuitry portion and the main output stage. Should be at the same potential as AVSS.
17	OUT-PB3	Output P-channel gate driver for Channel B
18	DGND	Digital Ground
19	DVDD1	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA2, OUT–NA2, OUT–NA3, OUT–PB2, OUT–NB2 and OUT–NB3. Should be at the same potential as AVDD1.
20	Out-PB2	Output P-channel gate driver for Channel B
21	DVDD2	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA1, OUT–NA1, OUT–PB1 and OUT–NB1. Can be at a different potential compared to DVDD1.
22	Out-PB1	Output P-channel gate driver for Channel B
23	N/C	No connect
24	Out-NB1	Output N-channel gate driver for Channel B

TABLE 2-1: PIN FUNCTION TABLE

TABLE 2-1:	PIN FUNCTIO	TABLE
Pin Number	Pin Name	Description
25	DVDD2	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA1, OUT–NA1, OUT–PB1 and OUT–NB1. Can be at a different potential compared to DVDD1.
26	DGND	Digital Ground
27	Out-NB2	Output N-channel gate driver for Channel B
28	DVDD1	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA2, OUT–NA2, OUT–NA3, OUT–PB2, OUT–NB2 and OUT–NB3. Should be at the same potential as AVDD1.
29	Out-NB3	Output N-channel gate driver for Channel B
30	DGND	Digital Ground
31	DVDD1	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA2, OUT–NA2, OUT–NA3, OUT–PB2, OUT–NB2 and OUT–NB3. Should be at the same potential as AVDD1.
32	OUT-NA3	Output N-channel gate drivers for Channel A
33	DVDD1	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA2, OUT–NA2, OUT–NA3, OUT–PB2, OUT–NB2 and OUT–NB3. Should be at the same potential as AVDD1.
34	Out-NA2	Output N-Channel gate drivers for Channel A
35	DGND	Digital Ground
36	DVDD2	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA1, OUT–NA1, OUT–PB1 and OUT–NB1. Can be at a different potential compared to DVDD1.
37	Out-NA1	Output N-channel gate drivers for Channel A
38	N/C	No connect
39	Out-PA1	Output P-channel gate drivers for Channel A
40	DVDD2	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA1, OUT–NA1, OUT–PB1 and OUT–NB1. Can be at a different potential compared to DVDD1.
41	OUT-PA2	Output P-channel gate drivers for Channel A
42	DVDD1	Gate drive supply voltage. Supplies digital circuitry portion of the gate driver and the main output stage for OUT–PA2, OUT–NA2, OUT–NA3, OUT–PB2, OUT–NB2 and OUT–NB3. Should be at the same potential as AVDD1.
43	DGND	Digital Ground
44	Out-PA3	Output P-channel gate drivers for Channel A
45	DVSS	Gate drive supply voltage for OUT–PA3 and OUT–PB3. Supplies digital circuitry portion and the main output stage. Should be at the same potential as AVSS.
46	VLL	Logic supply voltage
47	EN	Logic input enable control. When EN = L, all P-channel output drivers are high and all N-channel output drivers are low.
48	AVSS	Negative driver supply for OUT–PA3, OUT–PB3 and bias circuits. It is also connected to the IC substrate. It should be connected to the most negative potential.
Center Pad	AVSS	For the QFN package, the center pad is at AVSS potential. It should be externally connected to AVSS.

3.0 DETAILED DESCRIPTION

TABLE 3-1: POWER-UP SEQUENCE

Step	Connection	Description						
1	AV _{SS} , DV _{SS}	Negative gate drive supply and substrate bias						
2	V_{LL} , AV_{DD1} , DV_{DD1} and DV_{DD2}	Logic supply, positive gate drive supply and bias						

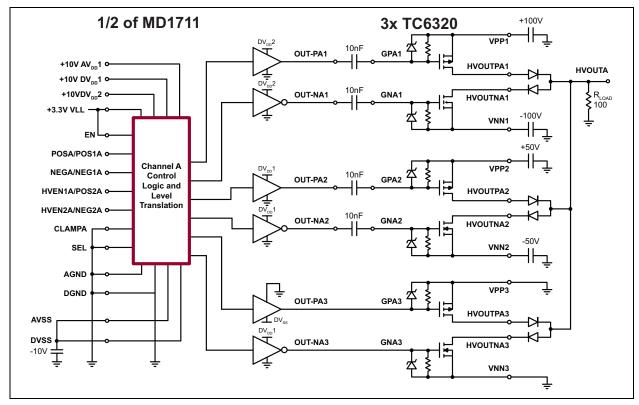


FIGURE 3-1: Test Circuit for Channel A.

TABLE 3-2: TRUTH FUNCTION TABLE FOR CHANNELS A AND B (FOR SEL = L)

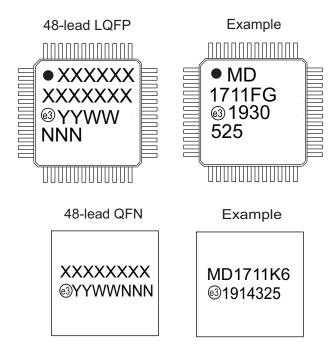
		Logic	Control I	Inputs			V _{PP} 1 to	o V _{NN} 1 tput	V _{PP} 2 to Out	o V _{NN} 2 tput	V _{PP} 3 to V _{NN} 3 Output		
SEL	EN	HVEN1/ POS2	HVEN2/ NEG2	Clamp	POS/ POS1	NEG/ NEG1	HV _{OUT} P1	HV _{OUT} N1	HV _{OUT} P2	HV _{OUT} N2	HV _{OUT} P3	HV _{OUT} N3	
0	1	0	0	0	0	0					ON	ON	
0	1	0	0	0	0	1		EE		FF	ON	ON	
0	1	0	0	0	1	0	- OFF			FF	ON	ON	
0	1	0	0	0	1	1					OFF	OFF	
0	1	0	0	1	0	0						•	
0	1	0	0	1	0	1		FF		FF	0	FF	
0	1	0	0	1	1	0]	ГГ		ГГ		FF	
0	1	0	0	1	1	1							
0	1	0	1	0	0	0			OFF	OFF	ON	ON	
0	1	0	1	0	0	1		FF	OFF	ON	OFF	OFF	
0	1	0	1	0	1	0		rr	ON	OFF	OFF	OFF	
0	1	0	1	0	1	1			OFF	OFF	OFF	OFF	
0	1	0	1	1	0	0			OFF				
0	1	0	1	1	0	1		FF				FF	
0	1	0	1	1	1	0		FF				FF	
0	1	0	1	1	1	1							
0	1	1	0	0	0	0	OFF	OFF			ON	ON	
0	1	1	0	0	0	1	OFF	ON			OFF	OFF	
0	1	1	0	0	1	0	ON	OFF			OFF	OFF	
0	1	1	0	0	1	1	OFF	OFF			OFF	OFF	
0	1	1	0	1	0	0	_						
0	1	1	0	1	0	1		FF		FF		FF	
0	1	1	0	1	1	0		'				' '	
0	1	1	0	1	1	1							
0	1	1	1	0	0	0							
0	1	1	1	0	0	1		FF		FF		FF	
0	1	1	1	0	1	0		OFF				' '	
0	1	1	1	0	1	1							
0	1	1	1	1	0	0							
0	1	1	1	1	0	1		FF		FF		FF	
0	1	1	1	1	1	0							
0	1	1	1	1	1	1							
0	0	X	Х	Х	Х	Х	0	FF	0	FF	0	FF	

TABLE 3-3: TRUTH FUNCTION TABLE FOR CHANNELS A AND B (FOR SEL = H)

		Logic	Control I	nputs				o V _{NN} 1 tput		o V _{NN} 2 tput	V _{PP} 3 to V _{NN} 3 Output	
SEL	EN	HVEN1/ POS2	HVEN2/ NEG2	Clamp	POS/ POS1	NEG/ NEG1	HV _{OUT} P1	HV _{OUT} N1	HV _{OUT} P2	HV _{OUT} N2	HV _{OUT} P3 HV _{OUT} N3	
1	1	0	0	0	0	0	OFF	OFF				
1	1	0	0	0	0	1	OFF	ON	OFF	OFF	OFF	
1	1	0	0	0	1	0	ON	OFF	OFF	OFF	OFF	
1	1	0	0	0	1	1	ON	ON				
1	1	0	0	1	0	0	OFF	OFF				
1	1	0	0	1	0	1	OFF	ON	OFF	ON	OFF	
1	1	0	0	1	1	0	ON	OFF	OFF	ON	OFF	
1	1	0	0	1	1	1	ON	ON				
1	1	0	1	0	0	0	OFF	OFF				
1	1	0	1	0	0	1	OFF	ON	ON	OFF	OFF	
1	1	0	1	0	1	0	ON	OFF	ON	OFF	OFF	
1	1	0	1	0	1	1	ON	ON				
1	1	0	1	1	0	0	OFF	OFF				
1	1	0	1	1	0	1	OFF	ON	ON	ON ON	OFF	
1	1	0	1	1	1	0	ON	OFF	ON		OFF	
1	1	0	1	1	1	1	ON	ON				
1	1	1	0	0	0	0	OFF	OFF				
1	1	1	0	0	0	1	OFF	ON	OFF	OFF	ON	
1	1	1	0	0	1	0	ON	OFF	OFF	OFF	ON	
1	1	1	0	0	1	1	ON	ON				
1	1	1	0	1	0	0	OFF	OFF				
1	1	1	0	1	0	1	OFF	ON	OFF	ON	ON	
1	1	1	0	1	1	0	ON	OFF	OFF	ON	ON	
1	1	1	0	1	1	1	ON	ON				
1	1	1	1	0	0	0	OFF	OFF				
1	1	1	1	0	0	1	OFF	ON	ON	OFF	ON	
1	1	1	1	0	1	0	ON	OFF	UN	UFF	ON	
1	1	1	1	0	1	1	ON	ON				
1	1	1	1	1	0	0	OFF	OFF				
1	1	1	1	1	0	1	OFF	ON	ON	ONI	ON	
1	1	1	1	1	1	0	ON	OFF	UN	ON	ON	
1	1	1	1	1	1	1	ON	ON				
1	0	Х	Х	Х	Х	Х	OFF	OFF	OFF	OFF	OFF	

4.0 PACKAGING INFORMATION

4.1 **Package Marking Information**



Legend: XX...X Product Code or Customer-specific information

Year code (last digit of calendar year) ΥY Year code (last 2 digits of calendar year) WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

(e3) Pb-free JEDEC® designator for Matte Tin (Sn)

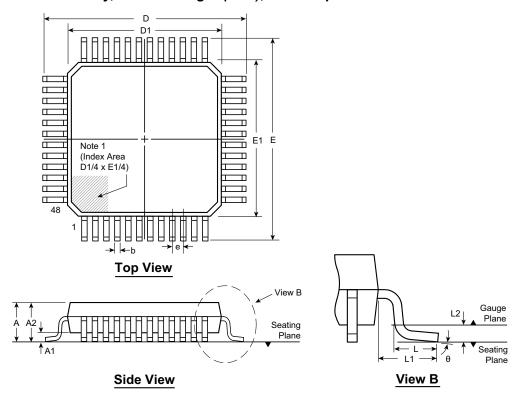
This package is Pb-free. The Pb-free JEDEC designator (@3)

can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

48-Lead LQFP Package Outline (FG)

7.00x7.00mm body, 1.60mm height (max), 0.50mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or

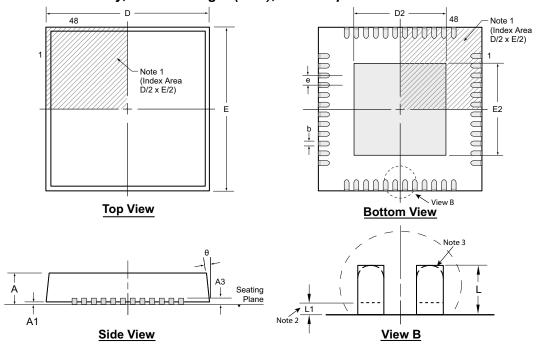
Symbo	ol	Α	A1	A2	b	D	D1	Е	E1	е	L	L1	L2	θ
	MIN	1.40*	0.05	1.35	0.17	8.80*	6.80*	8.80*	6.80*		0.45			0°
Dimension (mm)	NOM	-	-	1.40	0.22	9.00	7.00	9.00	7.00	0.50 BSC	0.60	1.00 REF	0.25 BSC	3.5°
(11111)	MAX	1.60	0.15	1.45	0.27	9.20*	7.20*	9.20*	7.20*	200	0.75		200	7 °

JEDEC Registration MS-026, Variation BBC, Issue D, Jan. 2001.
* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

48-Lead QFN Package Outline (K6)

7.00x7.00mm body, 1.00mm height (max), 0.50mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Notes:

- A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
- a printed indicator.

 2. Depending on the method of manufacturing, a maximum of 0.15mm pullback (L1) may be present.
- 3. The inner tip of the lead may be either rounded or square.

Symb	ol	Α	A1	A3	b	D	D2	E	E2	е	L	L1	θ
D	MIN	0.80	0.00	0.00	0.18	6.85*	1.25	6.85*	1.25	0.50	0.30 [†]	0.00	0 °
Dimension (mm)	NOM	0.90	0.02	0.20 REF	0.25	7.00	-	7.00	-	0.50 BSC	0.40 [†]	-	-
(11111)	MAX	1.00	0.05	IXLI	0.30	7.15*	5.45	7.15*	5.45	ВЗС	0.50 [†]	0.15	14°

JEDEC Registration MO-220, Variation VKKD-6, Issue K, June 2006.

Drawings are not to scale.

^{*} This dimension is not specified in the JEDEC drawing.

[†] This dimension differs from the JEDEC drawing.

MD1711

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (April 2019)

- Converted Supertex Doc# DSFP-MD1711 to Microchip DS20005740A
- · Changed package marking formats
- Changed the quantity of the 48-lead LQFP FG M931 media type from 3000/Reel to 1000/Reel
- Changed the quantity of the 48-lead VQFN K6 package from 250/Tray to 260/Tray
- Changed the quantity of the 48-lead VQFN K6 M933 media type from 2000/Reel to 3000/Reel
- Made minor text changes throughout the document

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u> </u>		- х - х	Examples:	
Device	Package Options		Environmental Media Type	a) MD1711FG-G:	High-Speed Integrated Ultrasound Driver IC, 48-lead LQFP, 250/Tray
Device:	MD1711	=	High-Speed Integrated Ultrasound Driver IC	b) MD1711FG-G-M931:	High-Speed Integrated Ultrasound Driver IC, 48-lead LQFP, 1000/Reel
Packages:	FG	=	48-lead LQFP		,
	K6	=	48-lead VQFN	c) MD1711K6-G:	High-Speed Integrated Ultrasound Driver IC,
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		48-lead VQFN, 260/Tray
Media Types:	(blank)	=	250/Tray for an FG Package 260/Tray for a K6 Package	Ú	High-Speed Integrated Ultrasound Driver IC,
	M931		,		48-lead VQFN, 3000/Reel
		=	1000/Reel for an FG Package		
	M933	=	3000/Reel for a K6 Package		

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
 knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
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- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not
 mean that we are guaranteeing the product as "unbreakable."

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Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200

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